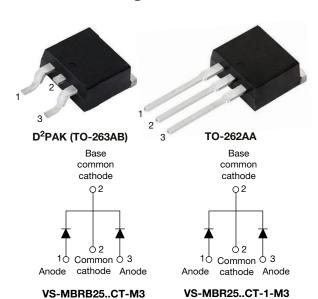
VS-MBRB25..CT-M3, VS-MBR25..CT-M3

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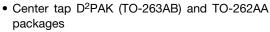
High Performance Schottky Rectifier, 2 x 15 A



PRIMARY CHARACTERISTICS					
I _{F(AV)}	2 x 15 A				
V_{R}	35 V, 45 V				
V _F at I _F	See datasheet				
I _{RM} max.	40 mA at 125 °C				
T _J max.	150 °C				
E _{AS}	16 mJ				
Package	D ² PAK (TO-263AB), TO-262AA				
Circuit configuration	Common cathode				

FEATURES

• 150 °C T_J operation





Low forward voltage drop

- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Rectangular waveform (per device)	30	^			
I _{FRM}	T _C = 130 °C (per leg)	30	A			
V _{RRM}		35/45	V			
I _{FSM}	t _p = 5 μs sine	1060	А			
V _F	30 A _{pk} , T _J = 125 °C	0.73	V			
T _J	Range	-65 to +150	°C			

VOLTAGE RATINGS							
PARAMETER	SYMBOL	VS-MBRB2535CT-M3 VS-MBR2535CT-1-M3	VS-MBRB2545CT-M3 VS-MBR2545CT-1-M3	UNITS			
Maximum DC reverse voltage	V_R	35	45	V			
Maximum working peak reverse voltage	V_{RWM}	33	45	V			



VS-MBRB25..CT-M3, VS-MBR25..CT-M3

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ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	OL TEST CONDITIONS		VALUES	UNITS	
Maximum average per leg		$T_C = 130$ °C, rated V_B		15		
forward current per device	I _{F(AV)}	$I_C = 130^{\circ} \text{ C}, \text{ rated } V_R$		30		
Peak repetitive forward current per leg	I _{FRM}	I_{FRM} Rated V_R , square wave, 20 kHz, $T_C = 130 ^{\circ}\text{C}$		30		
Non-repetitive peak surge current	I _{FSM}	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated V _{RRM} applied	1060	А	
		Surge applied at rated load conditions halfwave, single phase, 60 Hz		150		
Non-repetitive avalanche energy per leg	E _{AS}	$T_J = 25 ^{\circ}\text{C}, I_{AS} = 2 \text{A}, L = 8 \text{mH}$		16	mJ	
Repetitive avalanche current per leg	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _B typical		2	Α	

ELECTRICAL SPECIFICATIONS						
PARAMETER	RAMETER SYMBOL TEST CONDITIONS		VALUES	UNITS		
Maximum forward voltage drop	V _{FM} ⁽¹⁾	30 A	T _J = 25 °C	0.82 V		
Maximum forward voltage drop	VFM (*)	30 A	T _J = 125 °C	0.73	V	
Maximum instantaneous	I _{RM} ⁽¹⁾	T _J = 25 °C	Rated DC voltage	0.2	mA	
reverse current	'RM '''	T _J = 125 °C	- hated DC voltage	40		
Threshold voltage	V _{F(TO)}	T T		0.355	V	
Forward slope resistance	r _t	$T_J = T_J$ maximum		12.3	mΩ	
Maximum junction capacitance	C _T	V _R = 5 V _{DC} (test signal range	ge 100 kHz to 1 MHz), 25 °C	700	pF	
Typical series inductance	L _S	Measured from top of terminal to mounting plane		8.0	nH	
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs	

Note

 $^{(1)}$ Pulse width < 300 μ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction tempera	ture range	TJ		-65 to 150	°C		
Maximum storage tempera	ture range	T _{Stg}		-65 to 175			
Maximum thermal resistance, junction to case per leg		R _{thJC}	DC operation	1.5	00.004		
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50	°C/W		
Annewigante weight				2	g		
Approximate weight				0.07	OZ.		
Maunting tayous	minimum		Non-lubricated threads	6 (5)	kgf · cm		
Mounting torque — maximum			Non-jubricated trireads	12 (10)	(lbf · in)		
Marking device			Case style D ² PAK (TO-263AB)	MBRB2 MBRB2	2535CT 2545CT		
			Case style TO-262AA	MBR25 MBR25			

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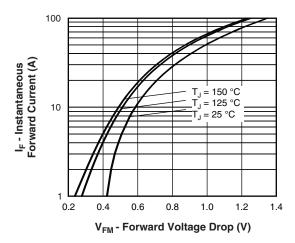


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

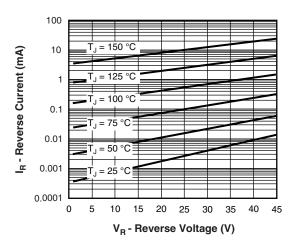


Fig. 2 - Typical Values of Reverse Current vs.Reverse Voltage (Per Leg)

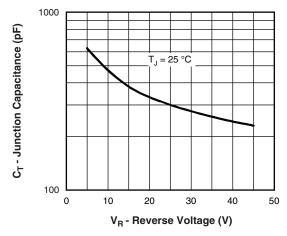


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

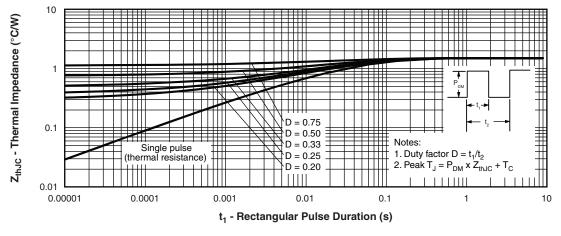


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)

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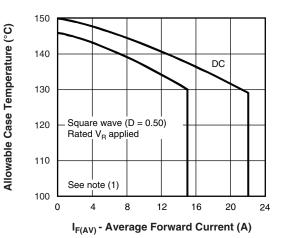


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

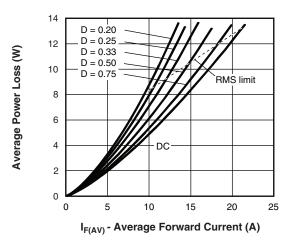


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

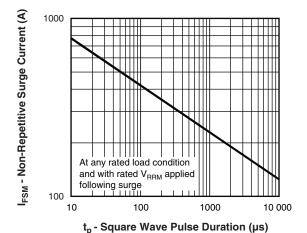


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

Note

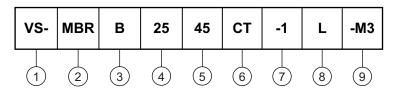
 $^{(1)}$ Formula used: T_C = T_J - (Pd + Pd_{REV}) x R_{thJC}; Pd = forward power loss = I_{F(AV)} x V_{FM} at (I_{F(AV)}/D) (see fig. 6); Pd_{REV} = inverse power loss = V_{R1} x I_R (1 - D); I_R at V_{R1} = rated V_R

VS-MBRB25..CT-M3, VS-MBR25..CT-M3

Vishay Semiconductors

ORDERING INFORMATION TABLE

Device code



Vishay Semiconductors product

Essential part number

• B = D²PAK (TO-263AB) None

• None = TO-262AA = -1

Current rating (25 = 25 A) 5

35 = 35 VVoltage ratings -45 = 45 V

CT = essential part number

• None = D^2PAK (TO-263AB) **3** = B

• -1 = TO-262AA 3 None

8 • None = tube

• L = tape and reel (left oriented - for D²PAK (TO-263AB) only)

• R = tape and reel (right oriented - for D²PAK (TO-263AB) only)

9 -M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION				
VS-MBRB2535CTL-M3	800	13" diameter plastic tape and reel				
VS-MBRB2535CT-M3	50	Antistatic plastic tubes				
VS-MBRB2535CTR-M3	800	13" diameter plastic tape and reel				
VS-MBRB2545CTL-M3	800	13" diameter plastic tape and reel				
VS-MBRB2545CT-M3	50	Antistatic plastic tubes				
VS-MBRB2545CTR-M3	800	13" diameter plastic tape and reel				
VS-MBR2535CT-1-M3	50	Antistatic plastic tubes				
VS-MBR2545CT-1-M3	50	Antistatic plastic tubes				

	LINKS TO RELATED DOCUMENTS					
Dimensions	D ² PAK (TO-263AB)	www.vishay.com/doc?96164				
Dimensions	TO-262AA	www.vishay.com/doc?96165				
Dart marking information	D ² PAK (TO-263AB)	www.vishay.com/doc?95444				
Part marking information	TO-262AA	www.vishay.com/doc?95443				
Packaging information		www.vishay.com/doc?96424				



Vishay Semiconductors

D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIM	ETERS	INC	HES	NOTES	
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOIES	IOIES	STINIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			E	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

Revision: 13-Jul-17 Document Number: 96164

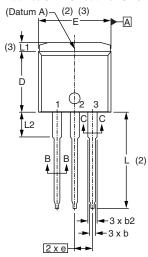


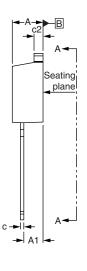
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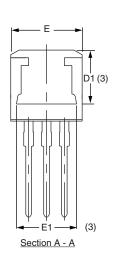
TO-262AA

DIMENSIONS in millimeters and inches

Modified JEDEC® outline TO-262







⊕ 0.010 **M** A**M** B

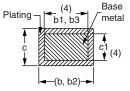
Lead assignments



Diodes 1. - Anode (two die)/open (one die)

2., 4. - Cathode

3. - Anode



Section B - B and C - C Scale: None

CVMDOL	MILLIM	IETERS	INC	INCHES			
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES		
Α	4.06	4.83	0.160	0.190			
A1	2.03	3.02	0.080	0.119			
b	0.51	0.99	0.020	0.039			
b1	0.51	0.89	0.020	0.035	4		
b2	1.14	1.78	0.045	0.070			
b3	1.14	1.73	0.045	0.068	4		
С	0.38	0.74	0.015	0.029			
c1	0.38	0.58	0.015	0.023	4		
c2	1.14	1.65	0.045	0.065			
D	8.51	9.65	0.335	0.380	2		
D1	6.86	8.00	0.270	0.315	3		
Е	9.65	10.67	0.380	0.420	2, 3		
E1	7.90	8.80	0.311	0.346	3		
е	2.54	BSC	0.10	0 BSC			
L	13.46	14.10	0.530	0.555			
L1	-	1.65	-	0.065	3		
L2	3.56	3.71	0.140	0.146			

Notes

(4) Dimension b1 and c1 apply to base metal only

Controlling dimension: inches

⁽¹⁾ Dimensioning and tolerancing as per ASME Y14.5M-1994
(2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

Thermal pad contour optional within dimension E, L1, D1 and E1

Outline conform to JEDEC® TO-262 except A1 (max.), b (min., max.), b1 (min.), b2 (max.), c (min.), c1(min.), c2 (max.), D (min.), E (max.), L1 (max.), L2 (min., max.)



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